

Low phase noise Fundamental Quartz Crystal Oscillator IC

GENERAL DESCRIPTION

The NJU6222 series is a C-MOS quartz crystal oscillator IC (20MHz to 50MHz) realized very low phase noise. It is consisted of an oscillation amplifier, divider (f_0 , $f_0/2$), and 3-state output buffer.

There are 2-type of pad location for Flip chip and Wire bonding that apply SMD's 2016-package and more miniature. The NJU6222 in low voltage operation features low phase noise, it is suitable for high quality Hi-Fi sound device, Communication device, and others by battery drive.

FEATURES

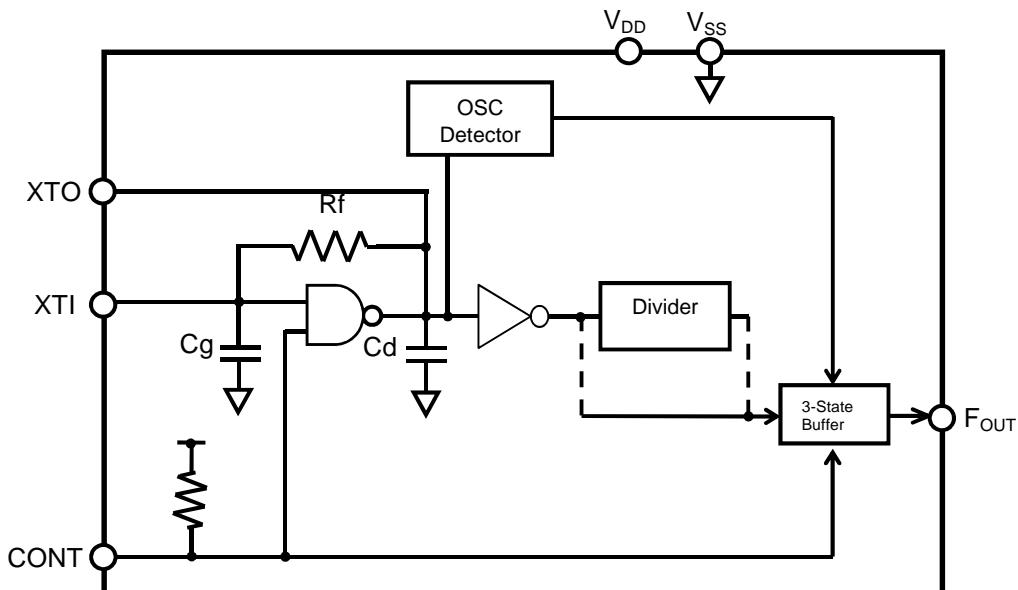
Oscillation Frequency	20~50MHz(Fundamental)
Frequency Stability	$\pm 1\text{ppm}$ @ $V_{DD}=1.8\text{V} \pm 10\%$, $V_{DD}=3.3\text{V} \pm 10\%$
Wide Operating Voltage	1.62 to 3.63V
Very Low Phase Noise	-103dBc/Hz(Typ.) @ 49.152MHz, 10Hz offset, $V_{DD}=1.8\text{V}$ -158dBc/Hz (Typ.) @ 49.152MHz, 1kHz offset, $V_{DD}=1.8\text{V}$ -103dBc/Hz(Typ.) @ 49.152MHz, 10Hz offset, $V_{DD}=3.3\text{V}$ -163dBc/Hz(Typ.) @ 49.152MHz, 1kHz offset, $V_{DD}=3.3\text{V}$
RMS Jitter	0.10psec(Typ.) 12kHz~20MHz, $V_{DD}=1.8\text{V}$ 0.05psec(Typ.) 12kHz~20MHz, $V_{DD}=3.3\text{V}$
Low Operating Current	3.1mA (Typ.) @ 49.152MHz, $V_{DD}=1.8\text{V}$, $CL=15\text{pF}$
Built-in Divider	f_0 , $f_0/2$ (Factory set)
Stand-by Function (CONT terminal: L)	Oscillation Stop and High Impedance Output "F _{OUT} " terminal
3-State Output Buffer	
Built-in Variable Pull-up Resistance (CONT: Pull-up Resistance large at the Stand-by mode.)	
Built-in Oscillation Capacitors C _g and C _d	
C-MOS Technology	
Package Outline	Die / 8-inch Wafer / 1/4 cut wafer

PACKAGE OUTLINE



NJU6222XxC-V

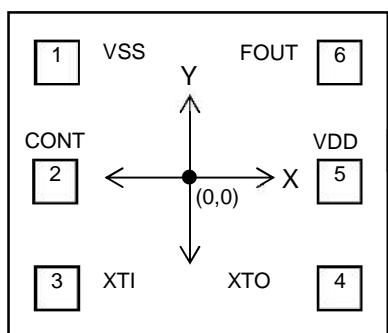
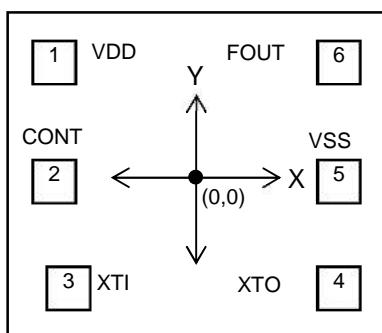
BLOCK DIAGRAM



LINE-UP TABLE

Type No.	F_{OUT}	Version	
		Type A	Type C
NJU6222	f_0	A1	C1
	$f_0/2$	A2	C2

PAD LOCATION

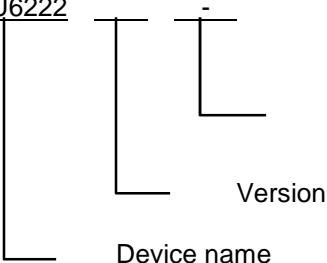
Type A
(For Flip Chip Bonding)Type C
(For Wire Bonding)

COORDINATES

Pad No.	X	Y
1	-174	190
2	-186	0
3	-174	-190
4	174	-190
5	186	0
6	174	190

PART NUMBER

NJU6222

W-V: Wafer (130µm)
C-V: Die (130µm)

Starting Point: Die Center Unit[µm]

Die Size: 0.580x0.588mm

Die Thickness (C-V): $130 \pm 15\mu m$ Wafer Thickness (W-V): $130 \pm 20\mu m$ Pad size: $80 \times 80\mu m$ Die Substrate: V_{SS} level

VERSION DISCRIMINATION INTERNAL COMPONENTS

PAD layout version of the NJU6222 series is determined by the version name in chip. Divide version of the NJU6222 series is determined by the internal fuse trimming.

Laser-trimmed versions are identified externally by the combination of the version name marking (1) and the locations of trimmed fuses (2). (Table 1 shows the chip version identification)

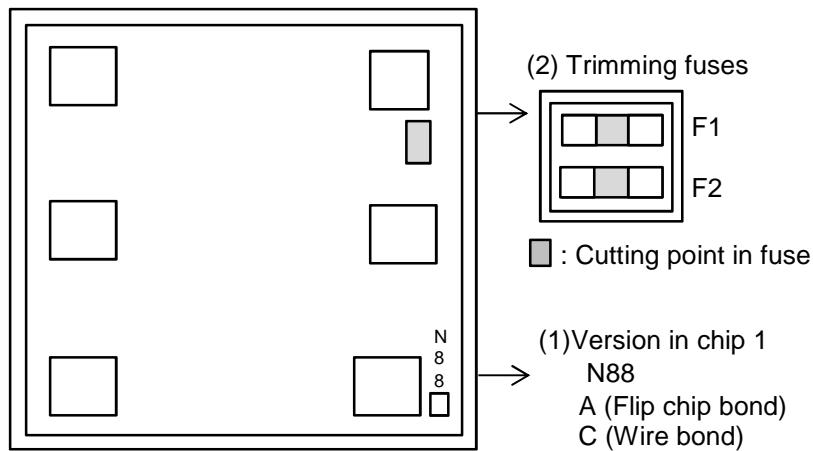


Table 1: Frequency version and Cutting point in fuse.

Version name	Mask / Version set by trimming fuses			
	Mask	Trimming fuses		
		Version	F1	F2
NJU6222A1	A	-	-	-
NJU6222A2	A	*	-	-
NJU6222C1	C	-	-	-
NJU6222C2	C	*	-	-

Note 1) “-”: Uncut, “*”: Cutting

TERMINAL DESCRIPTION

SYMBOL	FUNCTION	
CONT	Oscillation and 3-state Output Buffer Control	
	CONT	F _{OUT}
	H or OPEN	Output one frequency selected out of f ₀ and f _{0/2} Note1)
L	Oscillation Stop and High impedance Output	
XTI	Quartz Crystal Connection terminals	
XTO		
V _{SS}	GND terminal (V _{SS} =0V)	
F _{OUT}	Frequency Output terminal (3-State Output Buffer)	
V _{DD}	Power Supply terminal V _{DD} =1.62 to 3.63V	

Note1) Refer to the line-up table.

FUNCTIONAL DESCRIPTION

Standby Function

When CONT Terminal is "Low", the F_{OUT} Terminal output is High impedance.

CONT	F _{OUT}	Oscillator
High(Open)	Frequency output	Normal operation
Low	High impedance	Stop

When not using Stand-by function, CONT terminal is recommended to connect to V_{DD}.

Built-in Variable Pull-up Resistance of CONT terminal

The built-in pull-up resistance value of CONT Terminal changes in response to the input level. When CONT is "LOW" level, the pull-up resistance value is large to reduce the current consumption by the resistance. When CONT is open or connected to V_{DD}, the pull-up resistance value is small to decrease the input susceptibility to external noise. It works to prevent an unexpectedly stopping of the output by external noise.

ABSOLUTE MAXIMUM RATINGS

(V_{SS}=0V, Ta=25°C)

PARAMETER	SYMBOL	RATING	UNIT
Supply Voltage	V _{DD}	-0.6 to +6.0	V
Input Voltage	V _{IN}	-0.6 to +V _{DD} +0.6 and 6.0V	V
Output Voltage	V _O	-0.6 to V _{DD} +0.6	V
Input Current	I _{IN}	±10	mA
Output Current	I _O	±25	mA
Operating Temperature Range	T _{OPR}	-40 to +125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Note2) If the LSI used condition above the absolute maximum ratings, the LSI may be destroyed.

Use beyond the electric characteristics conditions will cause mal-function and poor reliability.

ELECTRICAL CHARACTERISTICS

(Ta=25°C)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Operating Voltage	V _{DD}	fosc=50MHz	1.62	-	3.63	V
Input Voltage	V _{IN}	CONT	0	-	3.63	V
Output Voltage	V _{OUT}	F _{OUT}	0	-	V _{DD}	V
Output Frequency Stability	df/f	V _{DD} ±10%	-	±1	-	ppm

(V_{DD}=1.62 to 3.63V, V_{SS}=0V, Ta=25°C)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Operating Current	I _{DD}	x1 version (f ₀) No load MEASURMENT CIRCUIT(1) f ₀ =49.152MHz Fout=49.152MHz	V _{DD} =1.8V	-	1.8	2.9
			V _{DD} =2.5V	-	3.3	4.8
			V _{DD} =3.3V	-	5.5	7.7
		x2 version (f ₀ /2) No load MEASURMENT CIRCUIT(1) f ₀ =49.152MHz Fout=24.576MHz	V _{DD} =1.8V	-	1.4	2.4
			V _{DD} =2.5V	-	2.7	4.1
			V _{DD} =3.3V	-	4.8	6.6
		x1 version (f ₀) CL=15pF MEASURMENT CIRCUIT(1) f ₀ =49.152MHz Fout=49.152MHz	V _{DD} =1.8V	-	3.1	4.1
			V _{DD} =2.5V	-	5.1	6.6
			V _{DD} =3.3V	-	7.9	9.9
		x2 version (f ₀ /2) CL=15pF MEASURMENT CIRCUIT(1) f ₀ =49.152MHz Fout=24.576MHz	V _{DD} =1.8V	-	2.0	3.0
			V _{DD} =2.5V	-	3.6	4.9
			V _{DD} =3.3V	-	5.9	7.7
Stand-by Current	I _{STB}	MESURMENT CIRCUIT(1) CONT=V _{SS}	V _{DD} =1.8V	-	3.0	25.0
			V _{DD} =2.5V	-	5.0	30.0
			V _{DD} =3.3V	-	9.0	35.0
Output Voltage	V _{OH}	MEASUREMENT CIRCUIT(2)	V _{DD} -0.4	-		V
	V _{OL}		-	-	0.4	V
Input Voltage	V _{IH}	MEASURMENT CIRCUIT(3)	0.7V _{DD}	-	-	V
	V _{IL}				0.3V _{DD}	V
Input Current	I _{IN}	MEASURMENT CIRCUIT(4) V _{DD} =1.62V, CONT=V _{DD}	-	-	0.065	μA
		MEASURMENT CIRCUIT(4) V _{DD} =1.62V, CONT=V _{SS}	-	-	-0.5	
		MEASURMENT CIRCUIT(4) VDD=3.63V, CONT=V _{SS}	-	-	0.150	
		MEASURMENT CIRCUIT(4) VDD=3.63V, CONT=V _{SS}	-10	-	-	
3-state Off Leakage Current	I _{OZ}	MEASURMENT CIRCUIT(5) CONT=V _{SS} , F _{OUT} = V _{DD} or V _{SS}	-	-	±0.1	μA

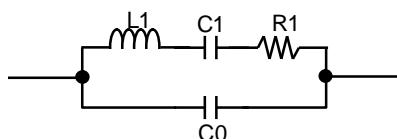
(V_{DD}=1.62 to 3.63V, V_{SS}=0V, Ta=25°C)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Feedback Resistance	R _f		-	50	-	kΩ
Built-in Oscillation Capacitor	C _g	f _{osc} =50MHz	-	8	-	pF
	C _d	f _{osc} =50MHz	-	17	-	pF
Oscillation Frequency	f _{osc}	Recommendation	-	-	50	MHz
Output Signal Symmetry	SYM	MEASURMENT CIRCUIT(1),@V _{DD} /2	45	50	55	%
Phase Noise	SSB	f _{OSC} =49.152MHz, V _{DD} =1.8V	10Hz offset	-	-103	-
			1kHz offset	-	-158	-
			Floor	-	-166	-
		f _{OSC} =49.152MHz, V _{DD} =3.3V	10Hz offset	-	-103	-
			1kHz offset	-	-163	-
			Floor	-	-172	-
Output Signal Rise Time	T _r	C _L =15pF 0.1V _{DD} to 0.9V _{DD}	V _{DD} =1.8V	-	3.1	4.7
			V _{DD} =2.5V	-	1.8	2.7
			V _{DD} =3.3V	-	1.3	2.0
Output Signal Fall Time	T _f	C _L =15pF 0.9V _{DD} to 0.1V _{DD}	V _{DD} =1.8V	-	2.8	4.2
			V _{DD} =2.5V	-	1.8	2.7
			V _{DD} =3.3V	-	1.4	2.1
Output Disable time	t _{POZ}	MEASURMENT CIRCUIT(6)	-	-	200	ns
Output Enable time	t _{PZO}	MEASURMENT CIRCUIT(6)	-	-	1.0	ms
Oscillation Start time	t _{osc}	MEASURMENT CIRCUIT(1)	-	-	1.0	ms

Note3) Decoupling capacitor ($\geq 0.01\mu F$) should be connected between V_{DD} and V_{SS} due to the stabilized operation of the circuit.

Note4) The oscillation frequency range has used NJRC's standard crystal for measurement. However it is not guaranteed. (Refer to EXAMPLE OF CRYSTAL PARAMETERS FOR MEASUREMENT CIRCUITS)

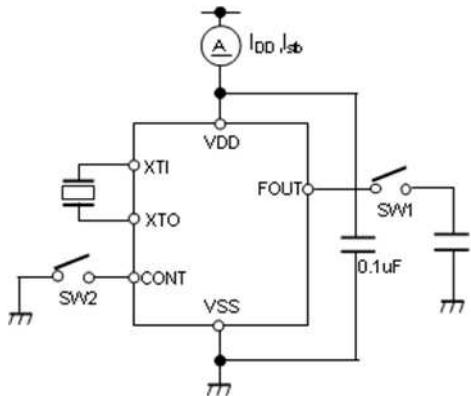
EXAMPLE OF CRYSTAL PARAMETERS FOR MEASUREMENT CIRCUITS



f[MHz]	R1[Ω]	L1[mH]	C1[fF]	C0[pF]
49.152	17.7	3.83	2.74	1.23

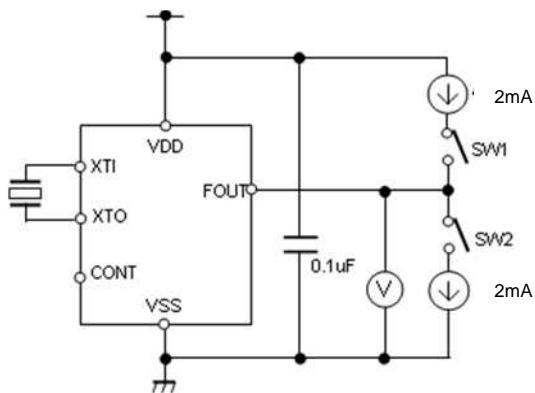
MEASUREMENT CIRCUITS

- (1) Operating Current, Stand-by Current, Output Signal Symmetry, Output Signal Rise/Fall Time
($C_L=0\text{pF}$, 15pF)



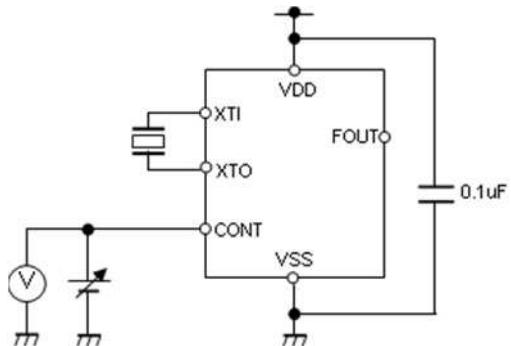
ITEM	SW1	SW2
$I_{DD}(\text{CL}=0\text{pF})$	OFF	OFF
$I_{DD}(\text{CL}=15\text{pF})$	ON	OFF
I_{stb}	ON or OFF	ON
SYM, tr, tf	ON	OFF
t_{osc}	ON	OFF

- (2) H Level, L Level Output Voltage

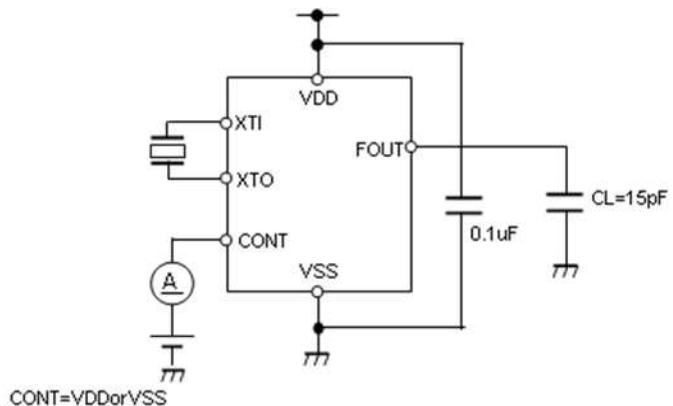


ITEM	SW1	SW2
V_{OH}	OFF	ON
V_{OL}	ON	OFF

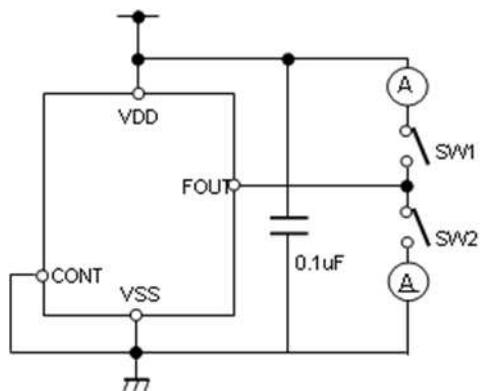
- (3) H Level, L Level Input Voltage



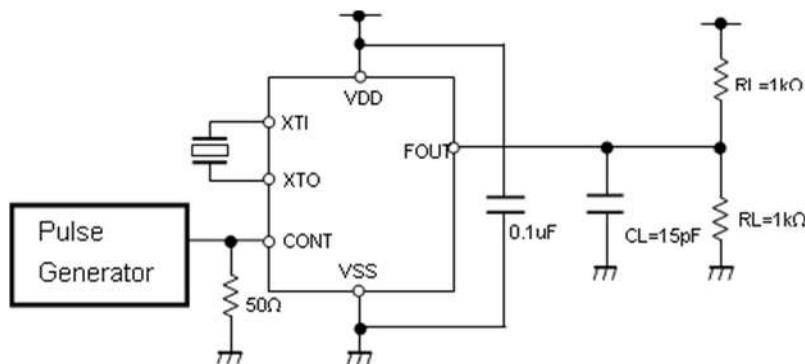
ITEM	F_{OUT}
$CONT > 0.7V_{DD}$	Oscillation
$CONT < 0.3V_{DD}$	Stop

(4) Input Current ($C_L=15pF$)

(5) 3-state Leakage Current



ITEM	SW1	SW2
I_{OZH}	ON	OFF
I_{OZL}	OFF	ON

(6) Output Disable Time ($CL=15pF$, $RL=1k\Omega$)

TIMING CHART

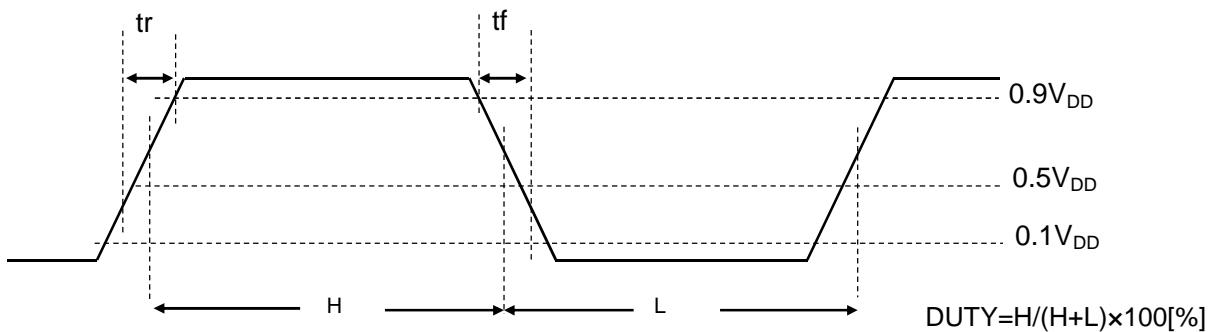


Fig.1 Output Signal Rise Time, Output Signal Fall Time, Output Symmetry

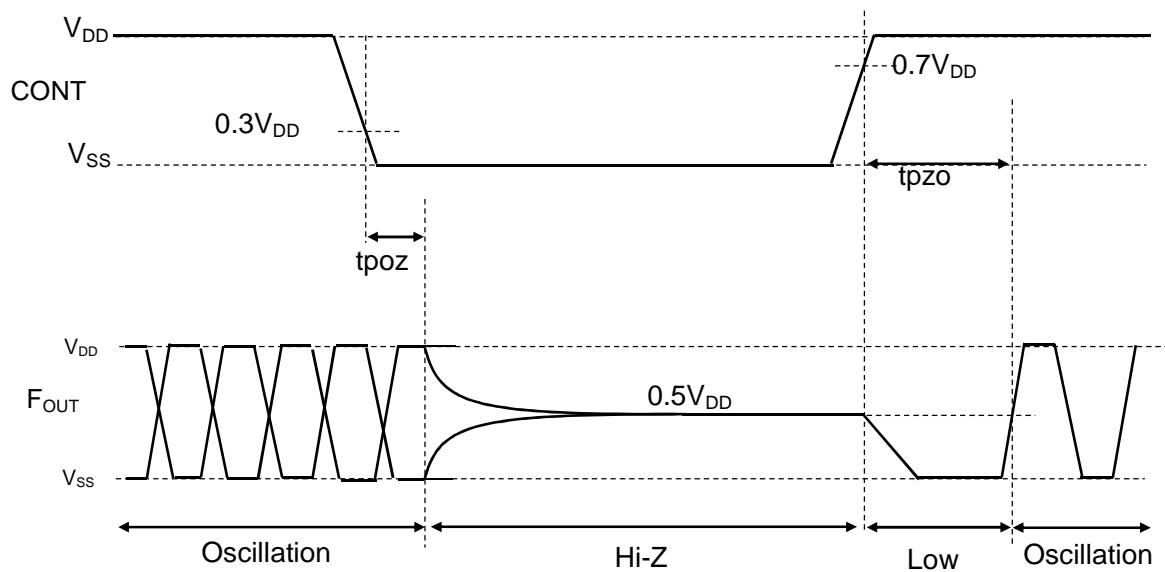
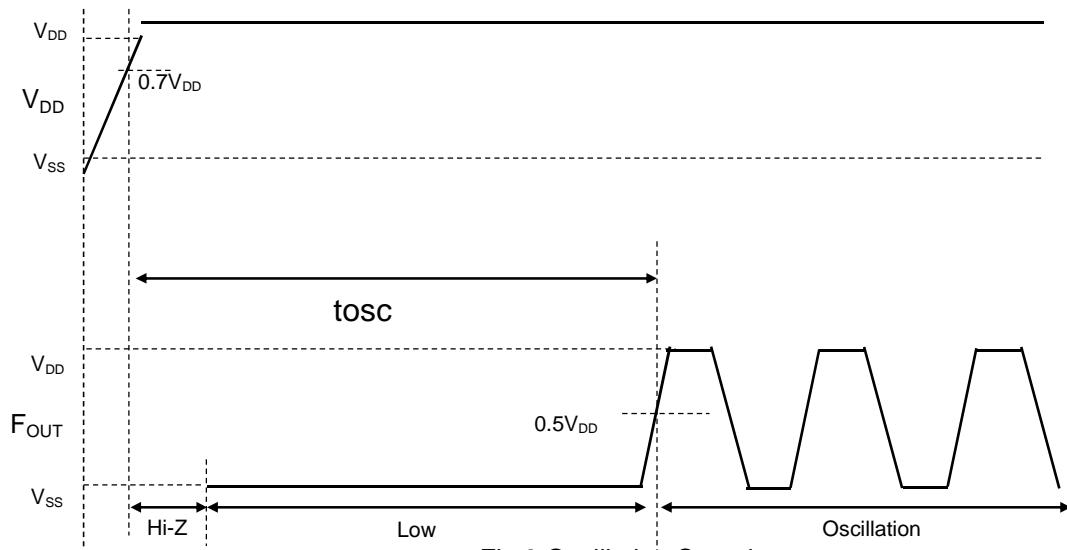
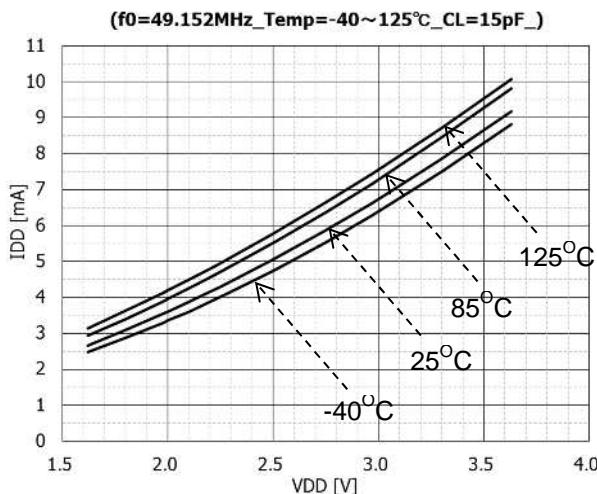
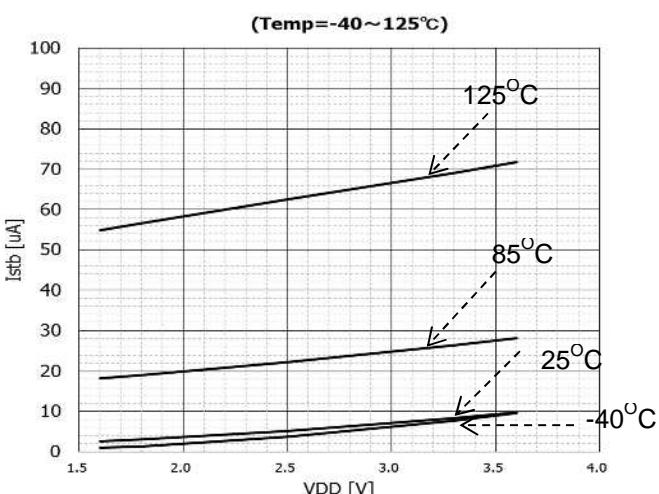


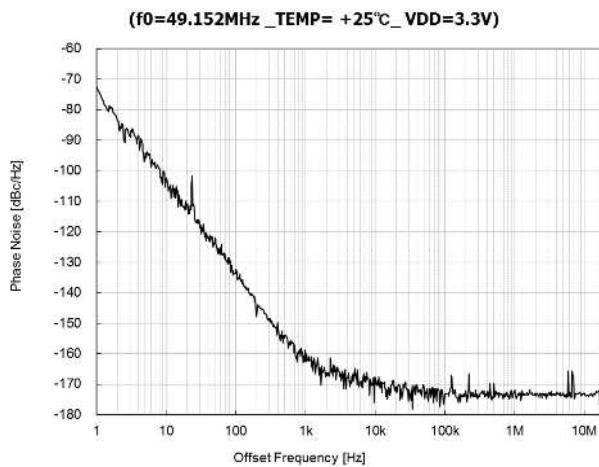
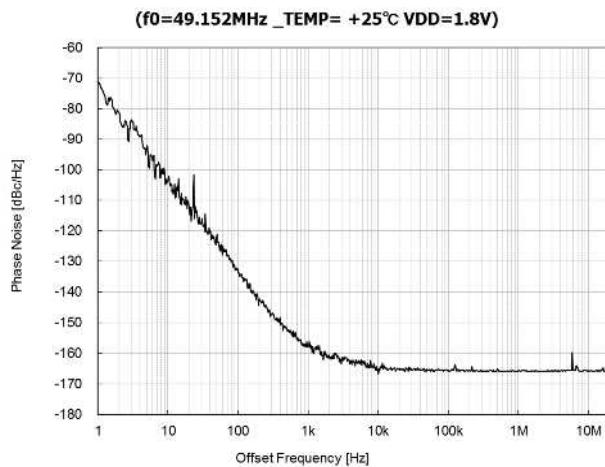
Fig.2 Output Disable time: tpoz, Output Enable time: tpzo, Timing Chart

Fig.3 Oscillation Start time: t_{osc}

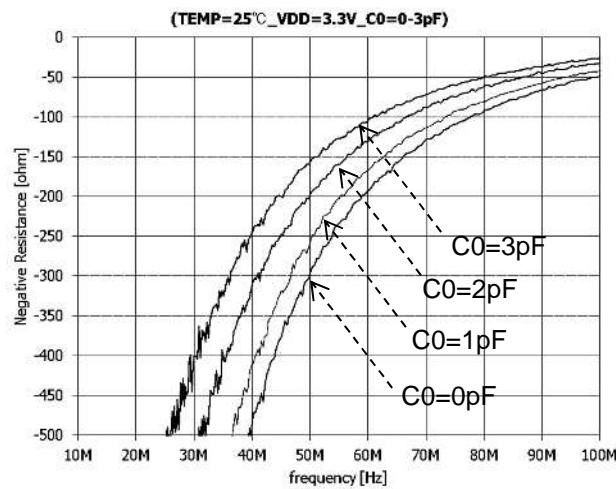
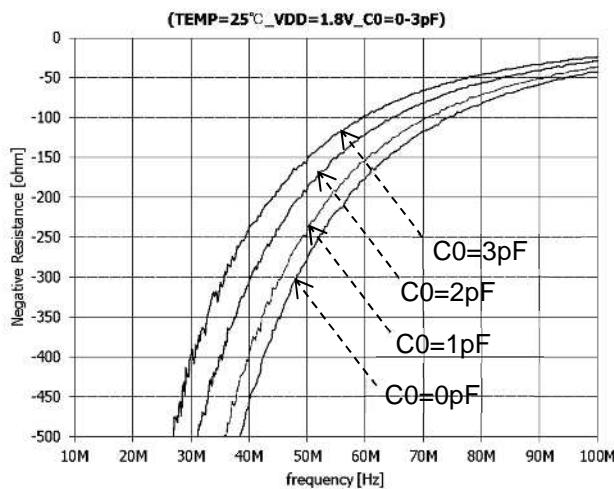
TYPICAL CHARACTERISTICS
 $I_{DD}(CL=15\text{pF})$

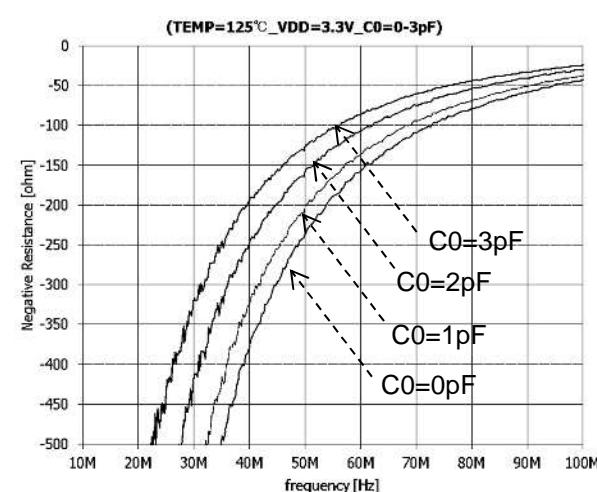
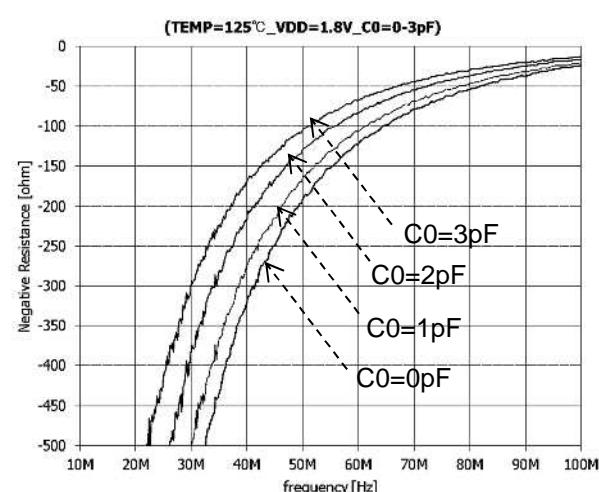
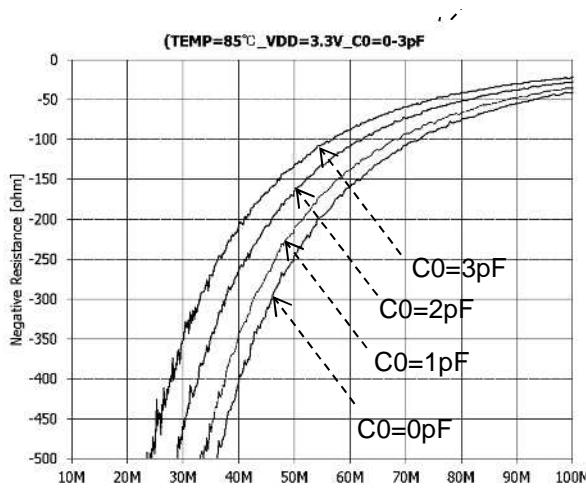
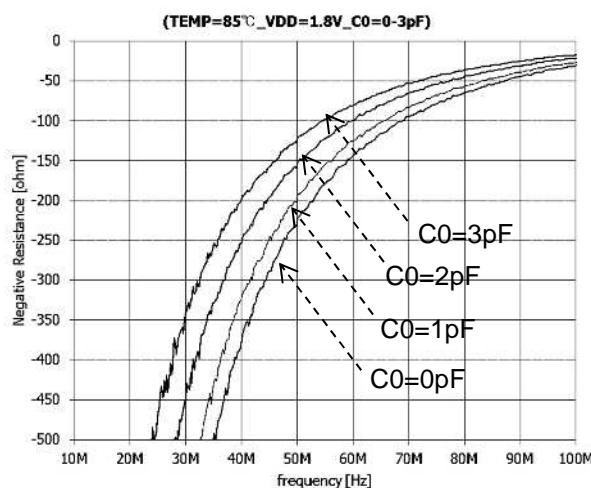
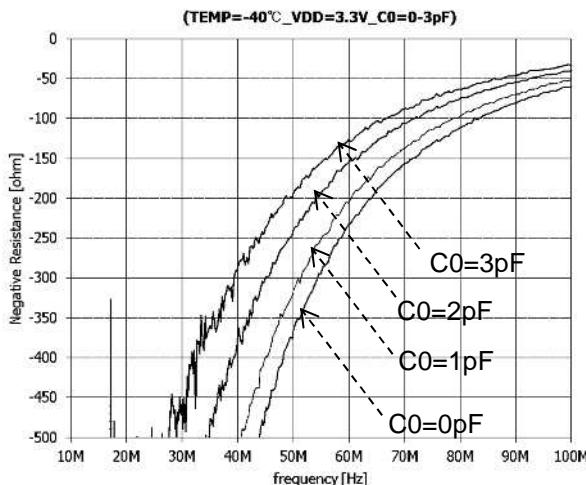
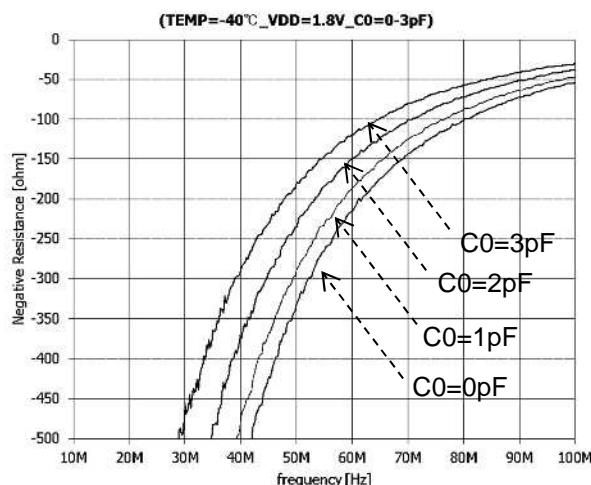
I_{stb}

Phase Noise



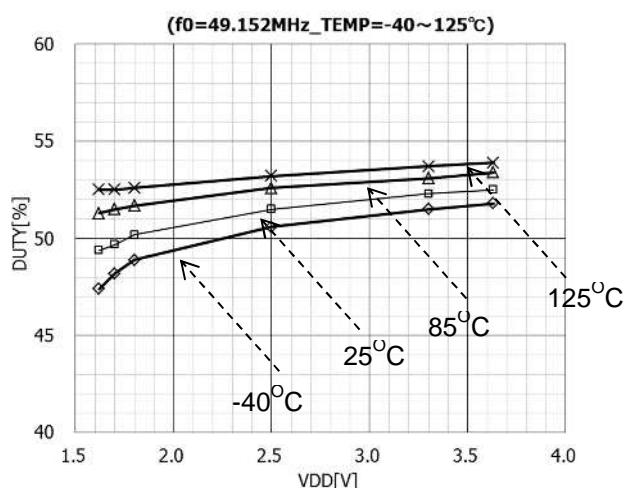
Negative Resistance



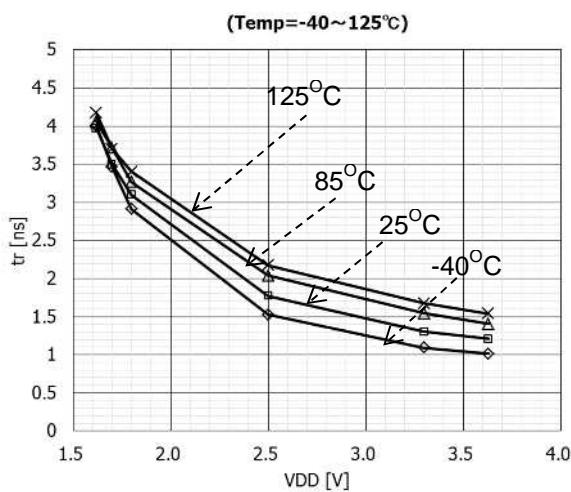


Note; A negative resistance 3 to 5 times the equivalent series resistance is said to be required for sufficient oscillation margin.

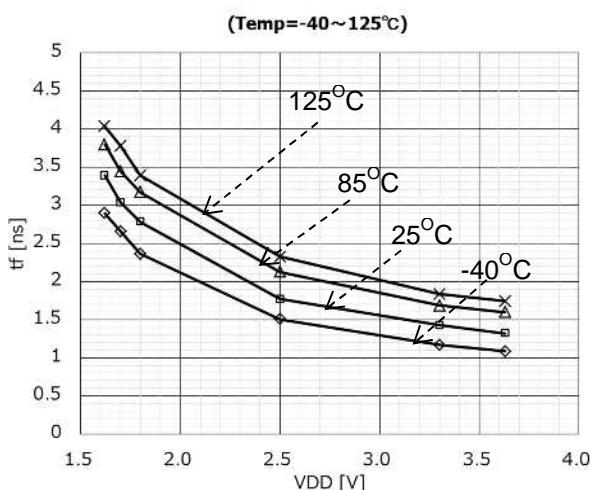
- SYM



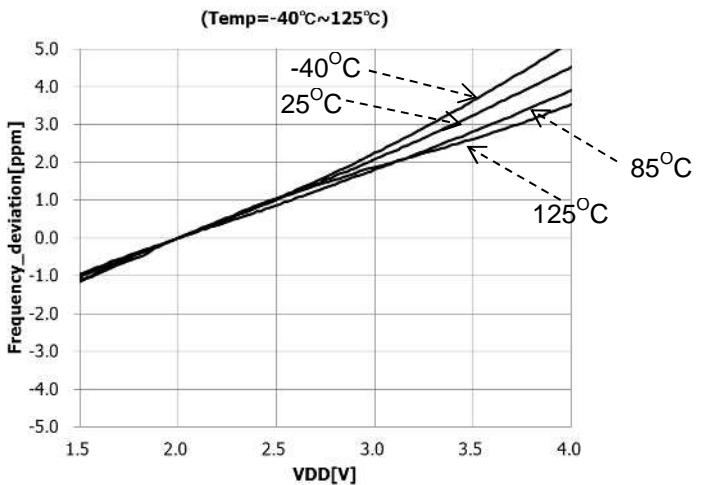
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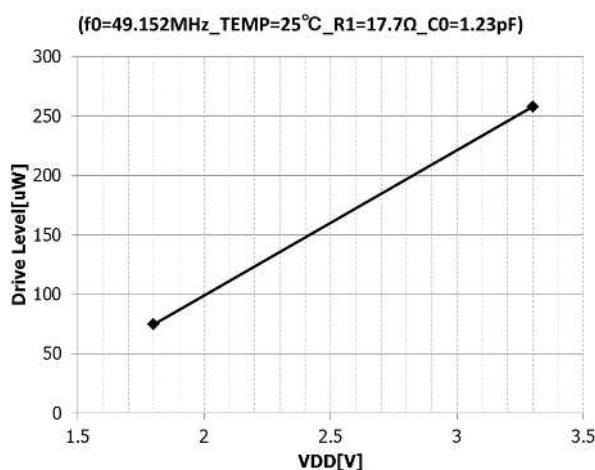
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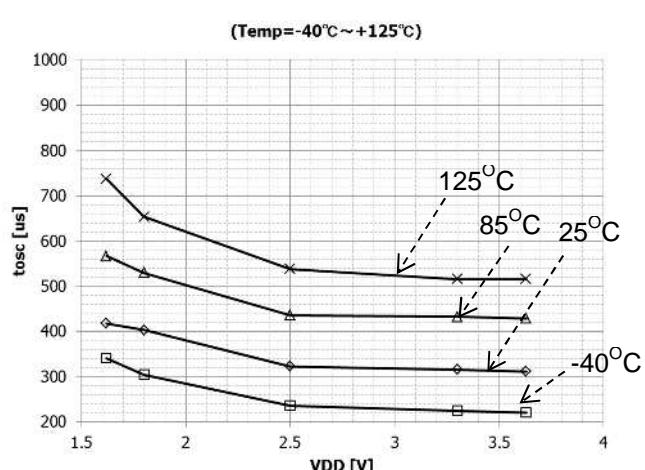
- df/f



- Drive Level



- t_{osc}



- Waveform



Fosc=49.152MHz, V_{DD}=1.8V, CL=15pF, Temp=25



Fosc=49.152MHz, V_{DD}=3.3V, CL=15pF, Temp=25

[CAUTION]

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